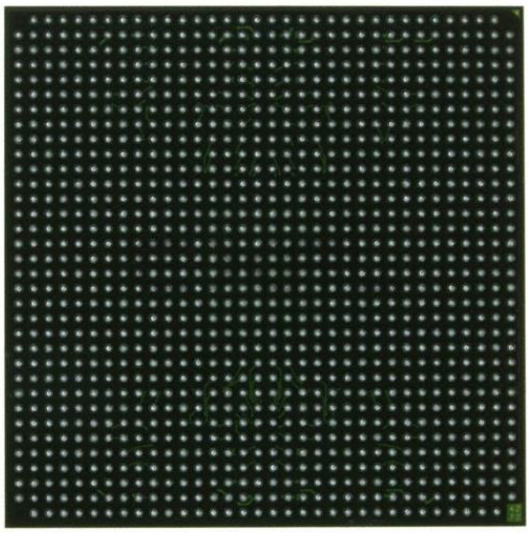
AMD Xilinx - XC2VP40-5FF1152C Datasheet



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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	4848
Number of Logic Elements/Cells	43632
Total RAM Bits	3538944
Number of I/O	692
Number of Gates	-
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1152-BBGA, FCBGA
Supplier Device Package	1152-FCBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2vp40-5ff1152c

Sum of Products

Each Virtex-II Pro slice has a dedicated OR gate named ORCY, ORing together outputs from the slices carryout and the ORCY from an adjacent slice. The ORCY gate with the dedicated Sum of Products (SOP) chain are designed for implementing large, flexible SOP chains. One input of each ORCY is connected through the fast SOP chain to the output of the previous ORCY in the same slice row. The second input is connected to the output of the top MUXCY in the same slice, as shown in Figure 43.

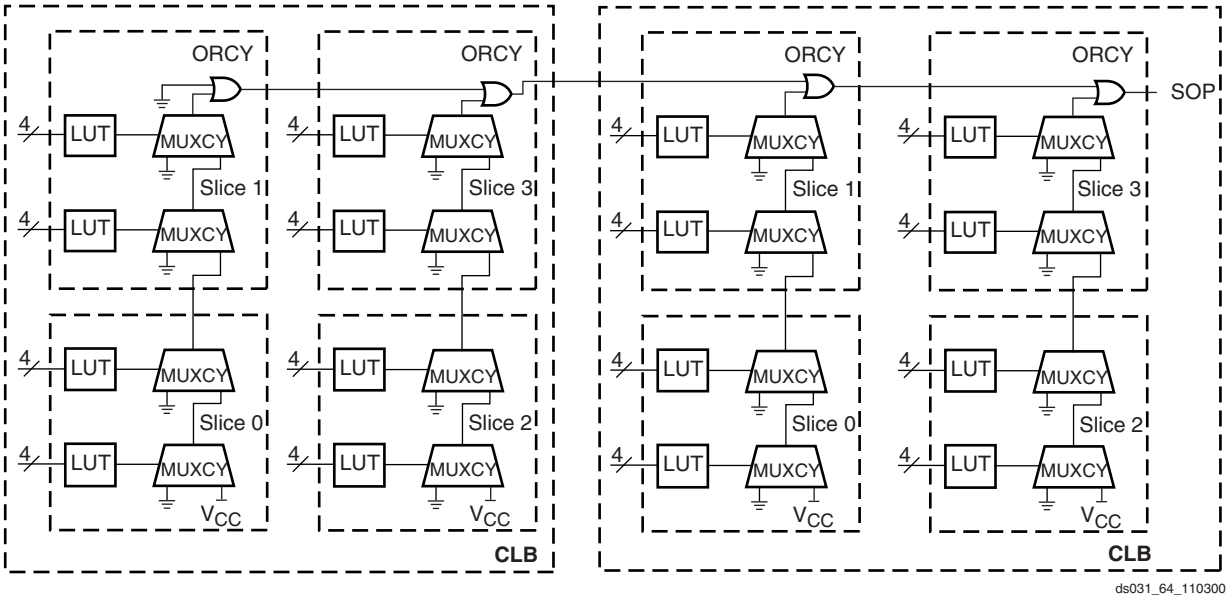

Figure 43: **Horizontal Cascade Chain**

LUTs and MUXCYs can implement large AND gates or other combinatorial logic functions. Figure 44 illustrates LUT and MUXCY resources configured as a 16-input AND gate.

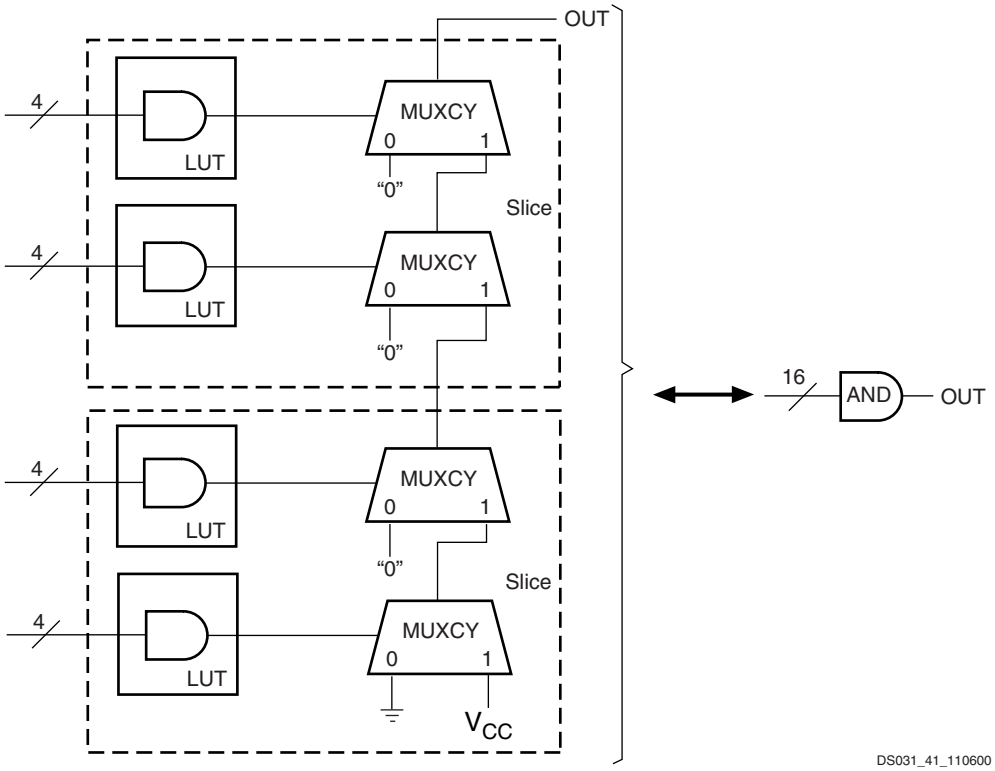

Figure 44: **Wide-Input AND Gate (16 Inputs)**

- The double lines route signals to every first or second block away in all four directions. Organized in a staggered pattern, double lines can be driven only at their endpoints. Double-line signals can be accessed either at the endpoints or at the midpoint (one block from the source).
- The direct connect lines route signals to neighboring blocks: vertically, horizontally, and diagonally.
- The fast connect lines are the internal CLB local interconnections from LUT outputs to LUT inputs.

Dedicated Routing

In addition to the global and local routing resources, dedicated signals are available.

- There are eight global clock nets per quadrant. (See Global Clock Multiplexer Buffers, page 48.)
- Horizontal routing resources are provided for on-chip 3-state buses. Four partitionable bus lines are provided per CLB row, permitting multiple buses within a row. (See 3-State Buffers, page 43.)
- Two dedicated carry-chain resources per slice column (two per CLB column) propagate carry-chain MUXCY output signals vertically to the adjacent slice. (See CLB/Slice Configurations, page 44.)
- One dedicated SOP chain per slice row (two per CLB row) propagate ORCY output logic signals horizontally to the adjacent slice. (See Sum of Products, page 42.)
- One dedicated shift-chain per CLB connects the output of LUTs in shift-register mode to the input of the next LUT in shift-register mode (vertically) inside the CLB. (See Shift Registers, page 39.)

Virtex-II Pro Receiver Data-Valid Window (R_X)

R_X is the required minimum aggregate valid data period for a source-synchronous data bus at the pins of the device and is calculated as follows:

$$R_X = [TSAMP^{(1)} + TCKSKEW^{(2)} + TPKGSKEW^{(3)}]$$

Notes:

1. This parameter indicates the total sampling error of Virtex-II Pro DDR input registers across voltage, temperature, and process. The characterization methodology uses the DCM to capture the DDR input registers' edges of operation. These measurements include:
   - CLK0 and CLK180 DCM jitter in a quiet system
   - Worst-case duty-cycle distortion
   - DCM accuracy (phase offset)
   - DCM phase shift resolution.

   These measurements do not include package or clock tree skew.
2. This value represents the worst-case clock-tree skew observable between sequential I/O elements. Significantly less clock-tree skew exists for I/O registers that are close to each other and fed by the same or adjacent clock-tree branches. Use the Xilinx FPGA_Editor and Timing Analyzer tools to evaluate clock skew specific to your application.
3. These values represent the worst-case skew between any two balls of the package: shortest flight time to longest flight time from Pad to Ball.

Revision History

This section records the change history for this module of the data sheet.

Date	Version	Revision
01/31/02	1.0	Initial Xilinx release.
06/17/02	2.0	• Added new Virtex-II Pro family members. • Added timing parameters from speedsfile **v1.62**. • Added Table 46, Pipelined Multiplier Switching Characteristics. • Added 3.3V-vs-2.5V table entries for some parameters.
09/03/02	2.1	• Added Source-Synchronous Switching Characteristics section. • Added absolute max ratings for 3.3V-vs-2.5V parameters in Table 1. • Added recommended operating conditions for V_{IN} and RocketIO footnote to Table 2. • Updated SSTL2 values in Table 6. Added SSTL18 values: Table 6, Table 39, Table 32. [Table 32 removed in v2.8.] • Added Table 10, which contains LVPECL DC specifications.
09/27/02	2.2	Added section General Power Supply Requirements.
11/20/02	2.3	Updated parametric information in: • Table 1: Increase Absolute Max Rating for V_{CCO}, V_{REF}, V_{IN}, and V_{TS} from 3.6V to 3.75V. Delete cautionary footnotes related to voltage overshoot/undershoot. • Table 2: Delete V_{CCO} specifications for 2.5V and below operation. Delete footnote referencing special information for 3.3V operation. Add footnote for PCI/PCI-X. • Table 3: Add I_{BATT}. Delete I_L specifications for 2.5V and below operation. • Table 4: Add Typical Quiescent Supply Currents for XC2VP4 and XC2VP7 only • Table 6: Correct I_{OL} and I_{OH} for SSTL2 I. Add rows for LVTTL, LVCMOS33, and PCI-X. Correct max V_{IH} from V_{CCO} to 3.6V. • Table 7: Correct Min/Max V_{OD}, V_{OCM}, and V_{ICM} • Table 10: Reformat LVPECL DC Specifications to match Virtex-II data sheet format • Table 12: Correct parameter name from Differential Output Voltage to Single-Ended Output Voltage Swing. • Table 16: Add CPMC405CLOCK max frequencies • Table 27: Add footnote regarding serial data rate limitation in -5 part. • Table 39: Add rows for LVTTL, LVCMOS33, and PCI-X. • Table 32: Add LVTTL, LVCMOS33, and PCI-X. Correct all capacitive load values (except PCI/PCI-X) to 0 pF. [Table 32 removed in v2.8.] • Table 51: Correct CCLK max frequencies
11/25/02	2.4	Table 1: Correct lower limit of voltage range of V_{IN} and V_{TS} from –0.3V to –0.5V for 3.3V.

Table 5: **FG256/FGG256 — XC2VP2 and XC2VP4**

Bank	Pin Description	Pin Number
N/A	AVCCAUXRX7	B13
N/A	AVCCAUXRX18	R13
N/A	VTRXPAD18	R12
N/A	RXNPAD18	T13
N/A	RXPPAD18	T12
N/A	GNDA18	P11
N/A	TXPPAD18	T11
N/A	TXNPAD18	T10
N/A	VTTXPAD18	R10
N/A	AVCCAUXTX18	R11
N/A	AVCCAUXRX19	R7
N/A	VTRXPAD19	R6
N/A	RXNPAD19	T7
N/A	RXPPAD19	T6
N/A	GNDA19	P6
N/A	TXPPAD19	T5
N/A	TXNPAD19	T4
N/A	VTTXPAD19	R4
N/A	AVCCAUXTX19	R5
N/A	VCCINT	N4
N/A	VCCINT	N13
N/A	VCCINT	M5
N/A	VCCINT	M12
N/A	VCCINT	E5
N/A	VCCINT	E12
N/A	VCCINT	D4
N/A	VCCINT	D13
N/A	VCCAUX	R16
N/A	VCCAUX	R1
N/A	VCCAUX	B16
N/A	VCCAUX	B1
N/A	GND	T16
N/A	GND	T1
N/A	GND	R2

Table 6: **FG456/FGG456 — XC2VP2, XC2VP4, and XC2VP7**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
6	IO_L06N_6	V1			
6	IO_L43P_6	U4	NC		
6	IO_L43N_6	U3	NC		
6	IO_L45P_6	U2	NC		
6	IO_L45N_6/VREF_6	U1	NC		
6	IO_L47P_6	U5	NC		
6	IO_L47N_6	T5	NC		
6	IO_L48P_6	T4	NC		
6	IO_L48N_6	T3	NC		
6	IO_L49P_6	T2	NC		
6	IO_L49N_6	T1	NC		
6	IO_L51P_6	R4	NC		
6	IO_L51N_6/VREF_6	R3	NC		
6	IO_L53P_6	R2	NC		
6	IO_L53N_6	R1	NC		
6	IO_L54P_6	R5	NC		
6	IO_L54N_6	P6	NC		
6	IO_L55P_6	P4	NC		
6	IO_L55N_6	P3	NC		
6	IO_L57P_6	P2	NC		
6	IO_L57N_6/VREF_6	P1	NC		
6	IO_L59P_6	P5	NC		
6	IO_L59N_6	N5	NC		
6	IO_L60P_6	N4	NC		
6	IO_L60N_6	N3	NC		
6	IO_L85P_6	N2			
6	IO_L85N_6	N1			
6	IO_L87P_6	N6			
6	IO_L87N_6/VREF_6	M6			
6	IO_L89P_6	M5			
6	IO_L89N_6	M4			
6	IO_L90P_6	M3			
6	IO_L90N_6	M2			
7	IO_L90P_7	L2			
7	IO_L90N_7	L3			
7	IO_L88P_7	L4			

Table 6: **FG456/FGG456 — XC2VP2, XC2VP4, and XC2VP7**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
0	VCCO_0	G9			
0	VCCO_0	G11			
0	VCCO_0	G10			
0	VCCO_0	F8			
0	VCCO_0	F7			
1	VCCO_1	G14			
1	VCCO_1	G13			
1	VCCO_1	G12			
1	VCCO_1	F16			
1	VCCO_1	F15			
2	VCCO_2	L16			
2	VCCO_2	K16			
2	VCCO_2	J16			
2	VCCO_2	H17			
2	VCCO_2	G17			
3	VCCO_3	T17			
3	VCCO_3	R17			
3	VCCO_3	P16			
3	VCCO_3	N16			
3	VCCO_3	M16			
4	VCCO_4	U16			
4	VCCO_4	U15			
4	VCCO_4	T14			
4	VCCO_4	T13			
4	VCCO_4	T12			
5	VCCO_5	U8			
5	VCCO_5	U7			
5	VCCO_5	T9			
5	VCCO_5	T11			
5	VCCO_5	T10			
6	VCCO_6	T6			
6	VCCO_6	R6			
6	VCCO_6	P7			
6	VCCO_6	N7			
6	VCCO_6	M7			
7	VCCO_7	L7			

Table 7: **FG676/FGG676 — XC2VP20, XC2VP30, and XC2VP40**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP20	XC2VP30	XC2VP40
N/A	GND	R15			
N/A	GND	R16			
N/A	GND	R24			
N/A	GND	T11			
N/A	GND	T12			
N/A	GND	T13			
N/A	GND	T14			
N/A	GND	T15			
N/A	GND	T16			
N/A	GND	U6			
N/A	GND	U21			
N/A	GND	W4			
N/A	GND	W23			
N/A	GND	AA10			
N/A	GND	AA17			
N/A	GND	AC4			
N/A	GND	AC8			
N/A	GND	AC19			
N/A	GND	AC23			
N/A	GND	AD3			
N/A	GND	AD24			
N/A	GND	AE2			
N/A	GND	AE25			
N/A	GND	AF1			
N/A	GND	AF26			

Notes:
1. See Table 4 for an explanation of the signals available on this pin.

Table 8: **FF672 — XC2VP2, XC2VP4, and XC2VP7**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
3	IO_L48N_3	W1	NC		
3	IO_L48P_3	W2	NC		
3	IO_L47N_3	W3	NC		
3	IO_L47P_3	W4	NC		
3	IO_L46N_3	W5	NC		
3	IO_L46P_3	W6	NC		
3	IO_L45N_3/VREF_3	Y1	NC		
3	IO_L45P_3	AA1	NC		
3	IO_L44N_3	Y3	NC		
3	IO_L44P_3	Y4	NC		
3	IO_L43N_3	Y5	NC		
3	IO_L43P_3	Y6	NC		
3	IO_L42N_3	AA2	NC	NC	NC
3	IO_L42P_3	AA3	NC	NC	NC
3	IO_L41N_3	AA4	NC	NC	NC
3	IO_L41P_3	AA5	NC	NC	NC
3	IO_L39N_3/VREF_3	AB1	NC	NC	NC
3	IO_L39P_3	AB2	NC	NC	NC
3	IO_L06N_3	AB3			
3	IO_L06P_3	AB4			
3	IO_L05N_3	AC1			
3	IO_L05P_3	AC2			
3	IO_L04N_3	AD1			
3	IO_L04P_3	AD2			
3	IO_L03N_3/VREF_3	AE1			
3	IO_L03P_3	AF2			
3	IO_L02N_3	AC3			
3	IO_L02P_3	AD4			
3	IO_L01N_3/VRP_3	AE3			
3	IO_L01P_3/VRN_3	AF3			
4	IO_L01N_4/BUSY/DOUT(1)	AC6			
4	IO_L01P_4/INIT_B	AD6			
4	IO_L02N_4/D0/DIN(1)	AB7			
4	IO_L02P_4/D1	AC7			
4	IO_L03N_4/D2	AA7			
4	IO_L03P_4/D3	AA8			

Table 8: **FF672 — XC2VP2, XC2VP4, and XC2VP7**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
6	IO_L52N_6	U22	NC		
6	IO_L53P_6	U23	NC		
6	IO_L53N_6	U24	NC		
6	IO_L54P_6	V26	NC		
6	IO_L54N_6	U26	NC		
6	IO_L55P_6	U20	NC		
6	IO_L55N_6	T19	NC		
6	IO_L56P_6	T20	NC		
6	IO_L56N_6	R20	NC		
6	IO_L57P_6	T21	NC		
6	IO_L57N_6/VREF_6	T22	NC		
6	IO_L58P_6	T23	NC		
6	IO_L58N_6	T24	NC		
6	IO_L59P_6	T25	NC		
6	IO_L59N_6	T26	NC		
6	IO_L60P_6	R19	NC		
6	IO_L60N_6	P19	NC		
6	IO_L85P_6	R21			
6	IO_L85N_6	R22			
6	IO_L86P_6	R23			
6	IO_L86N_6	R24			
6	IO_L87P_6	R25			
6	IO_L87N_6/VREF_6	R26			
6	IO_L88P_6	P20			
6	IO_L88N_6	P21			
6	IO_L89P_6	P22			
6	IO_L89N_6	P23			
6	IO_L90P_6	P24			
6	IO_L90N_6	P25			
7	IO_L90P_7	N25			
7	IO_L90N_7	N24			
7	IO_L89P_7	N23			
7	IO_L89N_7	N22			
7	IO_L88P_7	N21			
7	IO_L88N_7/VREF_7	N20			
7	IO_L87P_7	M26			

Table 8: **FF672 — XC2VP2, XC2VP4, and XC2VP7**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
N/A	VCCINT	U16			
N/A	VCCINT	U18			
N/A	VCCINT	V10			
N/A	VCCINT	V17			
N/A	VCCINT	V18			
N/A	VCCINT	W19			
N/A	VCCAUX	B2			
N/A	VCCAUX	N1			
N/A	VCCAUX	P1			
N/A	VCCAUX	A13			
N/A	VCCAUX	A14			
N/A	VCCAUX	AE2			
N/A	VCCAUX	B25			
N/A	VCCAUX	N26			
N/A	VCCAUX	P26			
N/A	VCCAUX	AE25			
N/A	VCCAUX	AF13			
N/A	VCCAUX	AF14			
N/A	GND	C3			
N/A	GND	D4			
N/A	GND	E5			
N/A	GND	F6			
N/A	GND	G7			
N/A	GND	Y7			
N/A	GND	AA6			
N/A	GND	AB5			
N/A	GND	AC4			
N/A	GND	AD3			
N/A	GND	C24			
N/A	GND	D23			
N/A	GND	E22			
N/A	GND	F21			
N/A	GND	G20			
N/A	GND	K10			
N/A	GND	K12			
N/A	GND	K13			
N/A	GND	K14			

Table 10: **FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50**

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
6	IO_L01P_6/VRN_6	AJ30				
6	IO_L01N_6/VRP_6	AJ31				
6	IO_L02P_6	AJ27				
6	IO_L02N_6	AJ28				
6	IO_L03P_6	AK31				
6	IO_L03N_6/VREF_6	AK32				
6	IO_L04P_6	AH29				
6	IO_L04N_6	AH30				
6	IO_L05P_6	AH27				
6	IO_L05N_6	AG28				
6	IO_L06P_6	AL33				
6	IO_L06N_6	AL34				
6	IO_L15P_6	AG29	NC			
6	IO_L15N_6/VREF_6	AG30	NC			
6	IO_L16P_6	AK33	NC			
6	IO_L16N_6	AK34	NC			
6	IO_L17P_6	AF27	NC			
6	IO_L17N_6	AF28	NC			
6	IO_L18P_6	AJ33	NC			
6	IO_L18N_6	AJ34	NC			
6	IO_L19P_6	AH31	NC			
6	IO_L19N_6	AH32	NC			
6	IO_L20P_6	AD25	NC			
6	IO_L20N_6	AD26	NC			
6	IO_L21P_6	AG31	NC			
6	IO_L21N_6/VREF_6	AG32	NC			
6	IO_L22P_6	AF29	NC			
6	IO_L22N_6	AF30	NC			
6	IO_L23P_6	AE27	NC			
6	IO_L23N_6	AE28	NC			
6	IO_L24P_6	AH33	NC			
6	IO_L24N_6	AH34	NC			
6	IO_L31P_6	AF31				
6	IO_L31N_6	AF32				
6	IO_L32P_6	AC25				
6	IO_L32N_6	AC26				
6	IO_L33P_6	AG33				
6	IO_L33N_6/VREF_6	AG34				

Table 12: **FF1517 — XC2VP50 and XC2VP70**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
2	IO_L11N_2	L9		
2	IO_L11P_2	M10		
2	IO_L12N_2	H4		
2	IO_L12P_2	J5		
2	IO_L13N_2	J1		
2	IO_L13P_2	J2		
2	IO_L14N_2	M8		
2	IO_L14P_2	N9		
2	IO_L15N_2	K6		
2	IO_L15P_2	K7		
2	IO_L16N_2/VREF_2	K4		
2	IO_L16P_2	K5		
2	IO_L17N_2	P10		
2	IO_L17P_2	N10		
2	IO_L18N_2	K3		
2	IO_L18P_2	J3		
2	IO_L19N_2	K1		
2	IO_L19P_2	K2		
2	IO_L20N_2	M11		
2	IO_L20P_2	N11		
2	IO_L21N_2	L7		
2	IO_L21P_2	L8		
2	IO_L22N_2/VREF_2	L5		
2	IO_L22P_2	L6		
2	IO_L23N_2	P8		
2	IO_L23P_2	P9		
2	IO_L24N_2	L3		
2	IO_L24P_2	L4		
2	IO_L25N_2	L1		
2	IO_L25P_2	L2		
2	IO_L26N_2	P11		
2	IO_L26P_2	P12		
2	IO_L27N_2	M6		
2	IO_L27P_2	M7		
2	IO_L28N_2/VREF_2	M2		
2	IO_L28P_2	M3		
2	IO_L29N_2	R9		
2	IO_L29P_2	R10		

Table 12: **FF1517 — XC2VP50 and XC2VP70**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
4	IO_L03N_4/D2	AN10		
4	IO_L03P_4/D3	AM10		
4	IO_L05_4/No_Pair	AK10		
4	IO_L06N_4/VRP_4	AR10		
4	IO_L06P_4/VRN_4	AP10		
4	IO_L07N_4	AU10		
4	IO_L07P_4/VREF_4	AT10		
4	IO_L08N_4	AJ12		
4	IO_L08P_4	AJ13		
4	IO_L09N_4	AL10		
4	IO_L09P_4/VREF_4	AL11		
4	IO_L19N_4	AN11		
4	IO_L19P_4	AM11		
4	IO_L20N_4	AH13		
4	IO_L20P_4	AH14		
4	IO_L21N_4	AR11		
4	IO_L21P_4	AP11		
4	IO_L25N_4	AU11		
4	IO_L25P_4	AT11		
4	IO_L26N_4	AL14		
4	IO_L26P_4	AK14		
4	IO_L27N_4	AM12		
4	IO_L27P_4/VREF_4	AL12		
4	IO_L28N_4	AT12	NC	
4	IO_L28P_4	AR12	NC	
4	IO_L29N_4	AJ14	NC	
4	IO_L29P_4	AJ15	NC	
4	IO_L30N_4	AM13	NC	
4	IO_L30P_4	AL13	NC	
4	IO_L34N_4	AP12	NC	
4	IO_L34P_4	AN13	NC	
4	IO_L35N_4	AL15	NC	
4	IO_L35P_4	AK15	NC	
4	IO_L36N_4	AT13	NC	
4	IO_L36P_4/VREF_4	AR13	NC	
4	IO_L37N_4	AN14		
4	IO_L37P_4	AM14		
4	IO_L38N_4	AH15		

Table 13: **FF1704 — XC2VP70, XC2VPX70, and XC2VP100**

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
7	IO_L87P_7		AA33		
7	IO_L87N_7		AA34		
7	IO_L86P_7		Y31		
7	IO_L86N_7		Y32		
7	IO_L85P_7		Y39		
7	IO_L85N_7		Y40		
7	IO_L60P_7		Y36		
7	IO_L60N_7		Y37		
7	IO_L59P_7		Y33		
7	IO_L59N_7		Y34		
7	IO_L58P_7		W41		
7	IO_L58N_7/VREF_7		W42		
7	IO_L57P_7		W39		
7	IO_L57N_7		W40		
7	IO_L56P_7		W31		
7	IO_L56N_7		W32		
7	IO_L55P_7		W37		
7	IO_L55N_7		W38		
7	IO_L54P_7		W35		
7	IO_L54N_7		W36		
7	IO_L53P_7		W33		
7	IO_L53N_7		W34		
7	IO_L52P_7		V41		
7	IO_L52N_7/VREF_7		V42		
7	IO_L51P_7		V38		
7	IO_L51N_7		V39		
7	IO_L50P_7		V31		
7	IO_L50N_7		U32		
7	IO_L49P_7		V35		
7	IO_L49N_7		V36		
7	IO_L48P_7		V32		
7	IO_L48N_7		V33		
7	IO_L47P_7		U31		
7	IO_L47N_7		T31		
7	IO_L46P_7		U41		
7	IO_L46N_7/VREF_7		U42		

Table 13: **FF1704 — XC2VP70, XC2VPX70, and XC2VP100**

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
7	IO_L45P_7		U39		
7	IO_L45N_7		U40		
7	IO_L44P_7		U33		
7	IO_L44N_7		U34		
7	IO_L43P_7		U37		
7	IO_L43N_7		U38		
7	IO_L42P_7		U35		
7	IO_L42N_7		U36		
7	IO_L41P_7		T32		
7	IO_L41N_7		T33		
7	IO_L40P_7		T40		
7	IO_L40N_7/VREF_7		T41		
7	IO_L39P_7		T38		
7	IO_L39N_7		T39		
7	IO_L38P_7		R35		
7	IO_L38N_7		T35		
7	IO_L37P_7		T36		
7	IO_L37N_7		T37		
7	IO_L36P_7		R31		
7	IO_L36N_7		R32		
7	IO_L35P_7		R41		
7	IO_L35N_7		R42		
7	IO_L34P_7		R40		
7	IO_L34N_7/VREF_7		P40		
7	IO_L33P_7		R37		
7	IO_L33N_7		R38		
7	IO_L32P_7		R33		
7	IO_L32N_7		R34		
7	IO_L31P_7		P41		
7	IO_L31N_7		P42		
7	IO_L30P_7		P37		
7	IO_L30N_7		P38		
7	IO_L29P_7		P31		
7	IO_L29N_7		P32		
7	IO_L28P_7		P35		
7	IO_L28N_7/VREF_7		P36		

Table 13: **FF1704 — XC2VP70, XC2VPX70, and XC2VP100**

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
N/A	RXPPAD17		BB15		
N/A	GNDA17		AY16		
N/A	TXPPAD17		BB16		
N/A	TXNPAD17		BB17		
N/A	VTTXPAD17		BA17		
N/A	AVCCAUXTX17		BA16		
N/A	AVCCAUXRX18		BA18		
N/A	VTRXPAD18		BA19		
N/A	RXNPAD18		BB18		
N/A	RXPPAD18		BB19		
N/A	GNDA18		AY21		
N/A	TXPPAD18		BB20		
N/A	TXNPAD18		BB21		
N/A	VTTXPAD18		BA21		
N/A	AVCCAUXTX18		BA20		
N/A	AVCCAUXRX19		BA22		
N/A	VTRXPAD19		BA23		
N/A	RXNPAD19		BB22		
N/A	RXPPAD19		BB23		
N/A	GNDA19		AY22		
N/A	TXPPAD19		BB24		
N/A	TXNPAD19		BB25		
N/A	VTTXPAD19		BA25		
N/A	AVCCAUXTX19		BA24		
N/A	AVCCAUXRX20		BA26		
N/A	VTRXPAD20		BA27		
N/A	RXNPAD20		BB26		
N/A	RXPPAD20		BB27		
N/A	GNDA20		AY27		
N/A	TXPPAD20		BB28		
N/A	TXNPAD20		BB29		
N/A	VTTXPAD20		BA29		
N/A	AVCCAUXTX20		BA28		
N/A	AVCCAUXRX21		BA30		
N/A	VTRXPAD21		BA31		
N/A	RXNPAD21		BB30		

Table 13: **FF1704 — XC2VP70, XC2VPX70, and XC2VP100**

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
N/A	VCCAUX		AM11		
N/A	VCCAUX		AN33		
N/A	VCCAUX		AN10		
N/A	VCCAUX		AV39		
N/A	VCCAUX		AV4		
N/A	VCCAUX		AW38		
N/A	VCCAUX		AW22		
N/A	VCCAUX		AW21		
N/A	VCCAUX		AW5		
N/A	VCCAUX		AA42		
N/A	VCCAUX		AA41		
N/A	VCCAUX		AA2		
N/A	VCCAUX		AA1		
N/A	VCCAUX		Y42		
N/A	VCCAUX		Y1		
N/A	VCCAUX		L32		
N/A	VCCAUX		L11		
N/A	VCCAUX		K33		
N/A	VCCAUX		K10		
N/A	VCCAUX		E39		
N/A	VCCAUX		E4		
N/A	VCCAUX		D38		
N/A	VCCAUX		D22		
N/A	VCCAUX		D21		
N/A	VCCAUX		D5		
N/A	GND		AB38		
N/A	GND		AB35		
N/A	GND		AB32		
N/A	GND		AB26		
N/A	GND		AB25		
N/A	GND		AB24		
N/A	GND		AB23		
N/A	GND		AB22		
N/A	GND		AB21		
N/A	GND		AB20		
N/A	GND		AB19		

Table 13: **FF1704 — XC2VP70, XC2VPX70, and XC2VP100**

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
N/A	GND		AA5		
N/A	GND		Y41		
N/A	GND		Y26		
N/A	GND		Y25		
N/A	GND		Y24		
N/A	GND		Y23		
N/A	GND		Y22		
N/A	GND		Y21		
N/A	GND		Y20		
N/A	GND		Y19		
N/A	GND		Y18		
N/A	GND		Y17		
N/A	GND		Y2		
N/A	GND		W26		
N/A	GND		W25		
N/A	GND		W24		
N/A	GND		W23		
N/A	GND		W22		
N/A	GND		W21		
N/A	GND		W20		
N/A	GND		W19		
N/A	GND		W18		
N/A	GND		W17		
N/A	GND		V37		
N/A	GND		V34		
N/A	GND		V26		
N/A	GND		V25		
N/A	GND		V24		
N/A	GND		V23		
N/A	GND		V22		
N/A	GND		V21		
N/A	GND		V20		
N/A	GND		V19		
N/A	GND		V18		
N/A	GND		V17		
N/A	GND		V9		

Table 14: **FF1696 — XC2VP100**

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
7	VCCO_7	AA29	
7	VCCO_7	Y29	
7	VCCO_7	W29	
7	VCCO_7	V29	
7	VCCO_7	U29	
7	VCCO_7	T29	
7	VCCO_7	R29	
7	VCCO_7	AA28	
7	VCCO_7	Y28	
7	VCCO_7	W28	
7	VCCO_7	V28	
7	VCCO_7	U28	
7	VCCO_7	T28	
6	VCCO_6	AU39	
6	VCCO_6	AN39	
6	VCCO_6	AJ39	
6	VCCO_6	AD39	
6	VCCO_6	AW37	
6	VCCO_6	AN35	
6	VCCO_6	AJ35	
6	VCCO_6	AD35	
6	VCCO_6	AR33	
6	VCCO_6	AL33	
6	VCCO_6	AH29	
6	VCCO_6	AG29	
6	VCCO_6	AF29	
6	VCCO_6	AE29	
6	VCCO_6	AD29	
6	VCCO_6	AC29	
6	VCCO_6	AB29	
6	VCCO_6	AG28	
6	VCCO_6	AF28	
6	VCCO_6	AE28	
6	VCCO_6	AD28	
6	VCCO_6	AC28	
6	VCCO_6	AB28	
5	VCCO_5	AW33	

Revision History

This section records the change history for this module of the data sheet.

Date	Version	Revision
01/31/02	1.0	Initial Xilinx release.
08/14/02	2.0	Added package and pinout information for new devices.
08/27/02	2.1	• Updated SelectIO-Ultra information in Table 4. (Table deleted in v2.3.) • Corrected direction for RXNPAD and TXPPAD in Table 4 (formerly Table 5).
09/27/02	2.2	Corrected Table 2 and Table 3 entries for XC2VP30, FF1152 package, maximum I/Os from 692 to 644.
11/20/02	2.3	Added Number of Differential Pairs data to Table 3. Removed former Table 4.
12/03/02	2.4	Corrections in Table 4: • Reclassified GCLKx (S/P) pins as Input/Output, since these pins can be used as normal I/Os if not used as clocks. • Added cautionary note to PWRDWN_B pin, indicating that this function is not supported.
01/20/03	2.5	Added and removed package/pinout information for existing devices: • In Table 1, added FG676 package information. • In Table 3, added FG676 package option for XC2VP20, XC2VP30, and XC2VP40. • In Table 12, removed FF1517 package option for XC2VP40. • Added FG676 package pinouts (Table 7) for XC2VP20, XC2VP30, and XC2VP40. • Added package diagram (Figure 3) for FG676 package.
05/19/03	2.5.1	• Added section **BREFCLK Pin Definitions**, page 5. • Added clarification to Table 4 and all device pinout tables regarding the dual-use nature of pins D0/DIN and BUSY/DOUT during configuration.
06/19/03	2.5.3	• Added notation of "open-drain" to TDO pin in Table 4. • The final GND pin in each of six pinout tables was inadvertently deleted in v2.5.1. This revision restores the deleted GND pins as follows: - Pin A1, Table 6, page 16 (FG456) - Pin AF26, Table 7, page 30 (FG676) - Pin AN34, Table 10, page 98 (FF1152) - Pin E1, Table 11, page 130 (FF1148) - Pin C38, Table 12, page 162 (FF1517) - Pin E1, Table 14, page 253 (FF1696)
08/25/03	2.5.5	• Table 4: Deleted Note 2, obsolete. There is only one GNDA pin per MGT. • Table 4: Deleted pins ALT_VRP and ALT_VRN. Not used in Virtex-II Pro FPGAs.
12/10/03	3.0	• XC2VP2 through XC2VP70 speed grades -5, -6, and -7, and XC2VP100 speed grades -5 and -6, are released to **Production status**.
02/19/04	3.1	• Table 4, signal descriptions column: - For signals TDI, TMS, and TCK, added: Pins are 3.3V-compatible. - For signals M2, M1, M0, added: Tie to 3.3V only with 100Ω series resistor. No toggling during or after configuration. - For signal TDO, added: No internal pull-up. External pull-up to 3.3V OK with resistor greater than 200Ω.
03/09/04	3.1.1	• Recompiled for backward compatibility with Acrobat 4 and above. No content changes.
06/30/04	4.0	Merged in DS110-4 (Module 4 of Virtex-II Pro X data sheet). Added data on available Pb-free packages and updated package diagrams for affected devices.